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(12) **United States Design Patent**
Shiwaku et al.

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(54) **EARPHONE**

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(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (12) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/223**

(58) **Field of Classification Search**

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379/430, 431; 381/380, 381, 370, 371,
381/153, 382, 328; 455/90.3, 575.1,
455/569.1

CPC H04R 1/10; H04R 25/00; H04R 1/1066;
H04R 1/1016; H04R 5/033; H04R
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See application file for complete search history.

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(74) *Attorney, Agent, or Firm* — W&C IP

(57) **CLAIM**

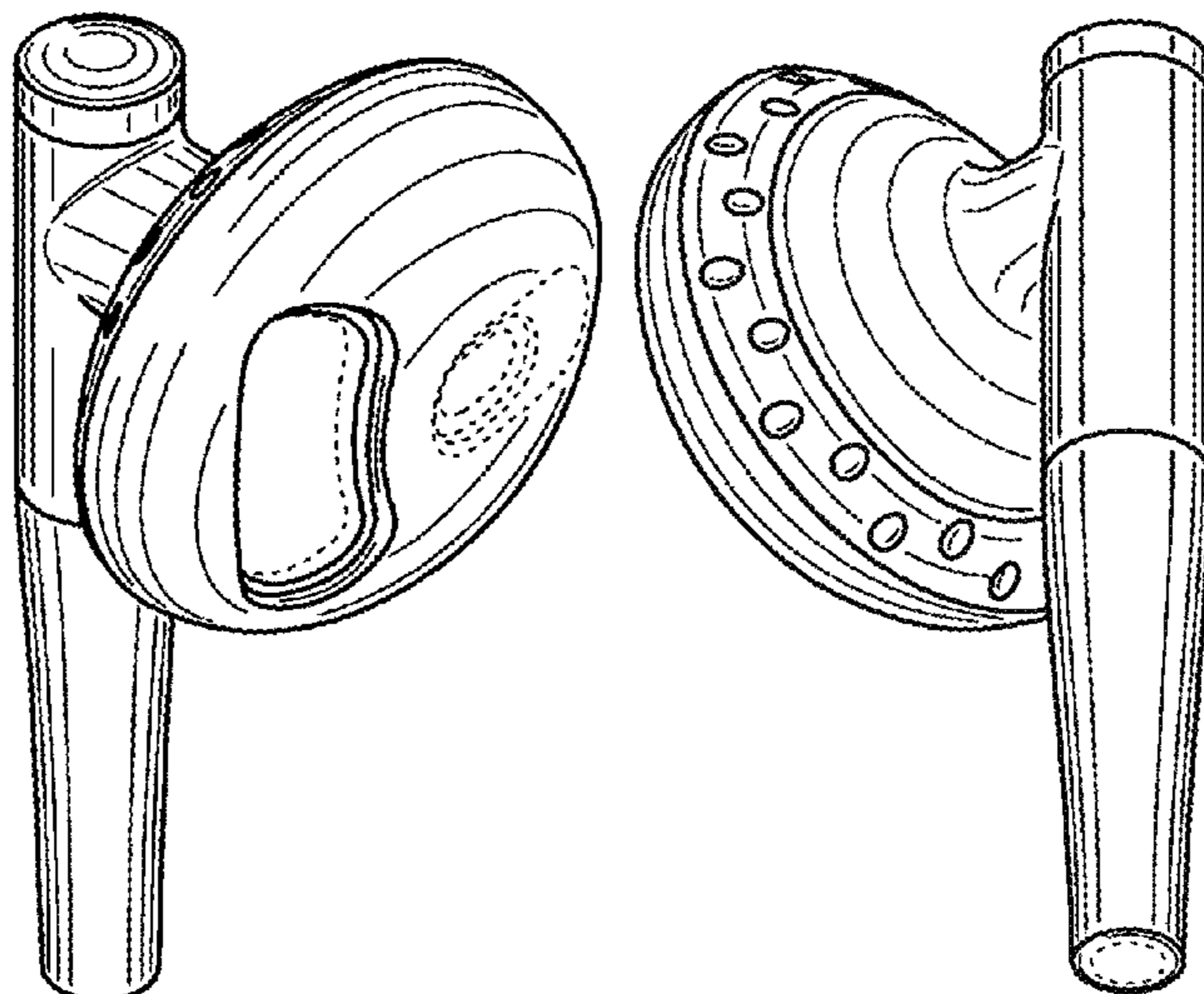
The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a front side perspective view of an earphone; FIG. 2 is a rear side perspective view of the earphone; FIG. 3 is a front elevational view of the earphone; FIG. 4 is a rear elevational view of the earphone; FIG. 5 is a top plan view of the earphone; FIG. 6 is a bottom plan view of the earphone; FIG. 7 is a left side elevational view of the earphone; FIG. 8 is a right side elevational view of the earphone; FIG. 9 is an enlarged end view of the earphone taken along line 9-9 of FIG. 5 with internal system omitted; and, FIG. 10 is a reference view showing a state of use of the earphone.

Portions of the drawings shown in broken lines form no part of the claimed design.

1 Claim, 10 Drawing Sheets



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FIG. 1

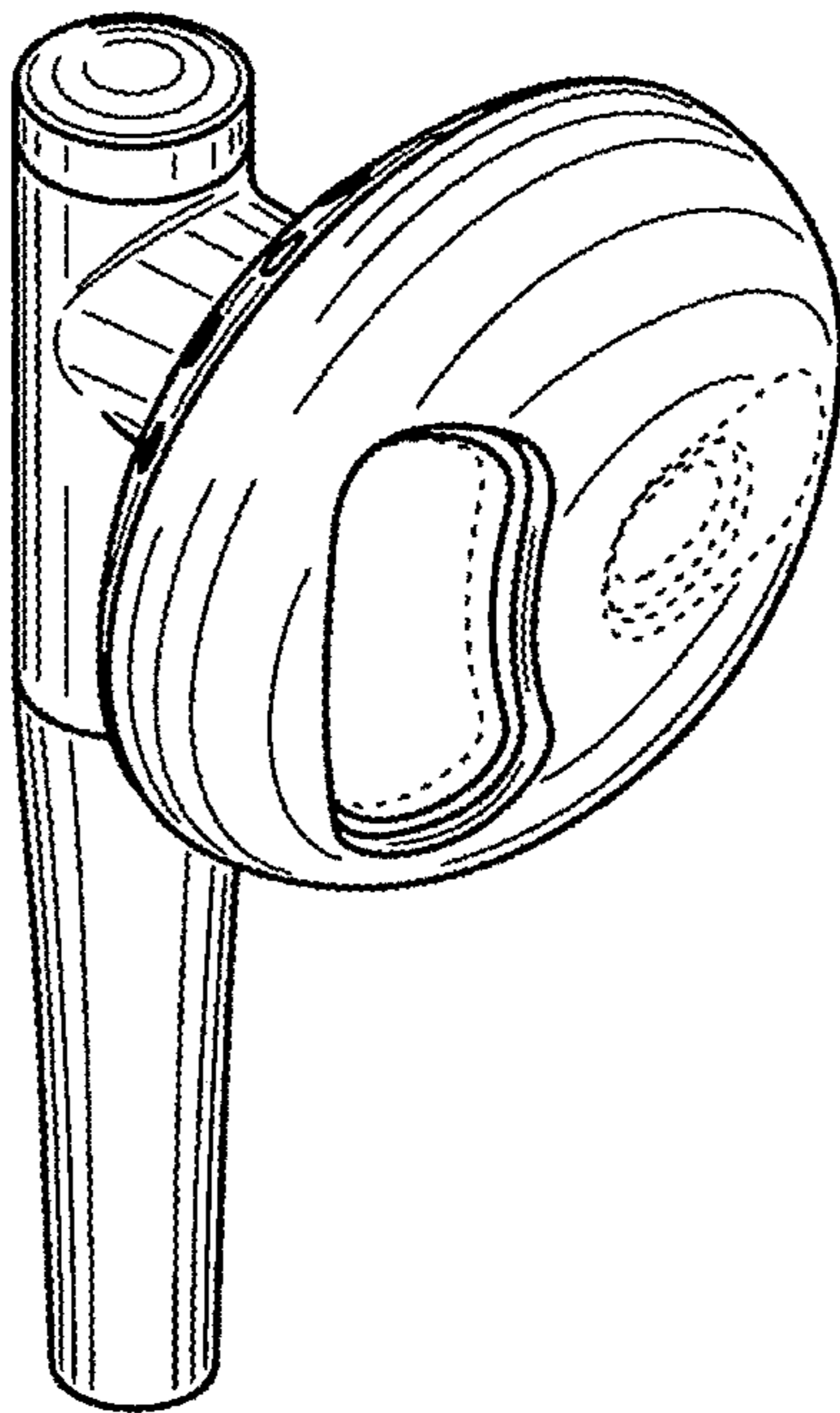


FIG. 2

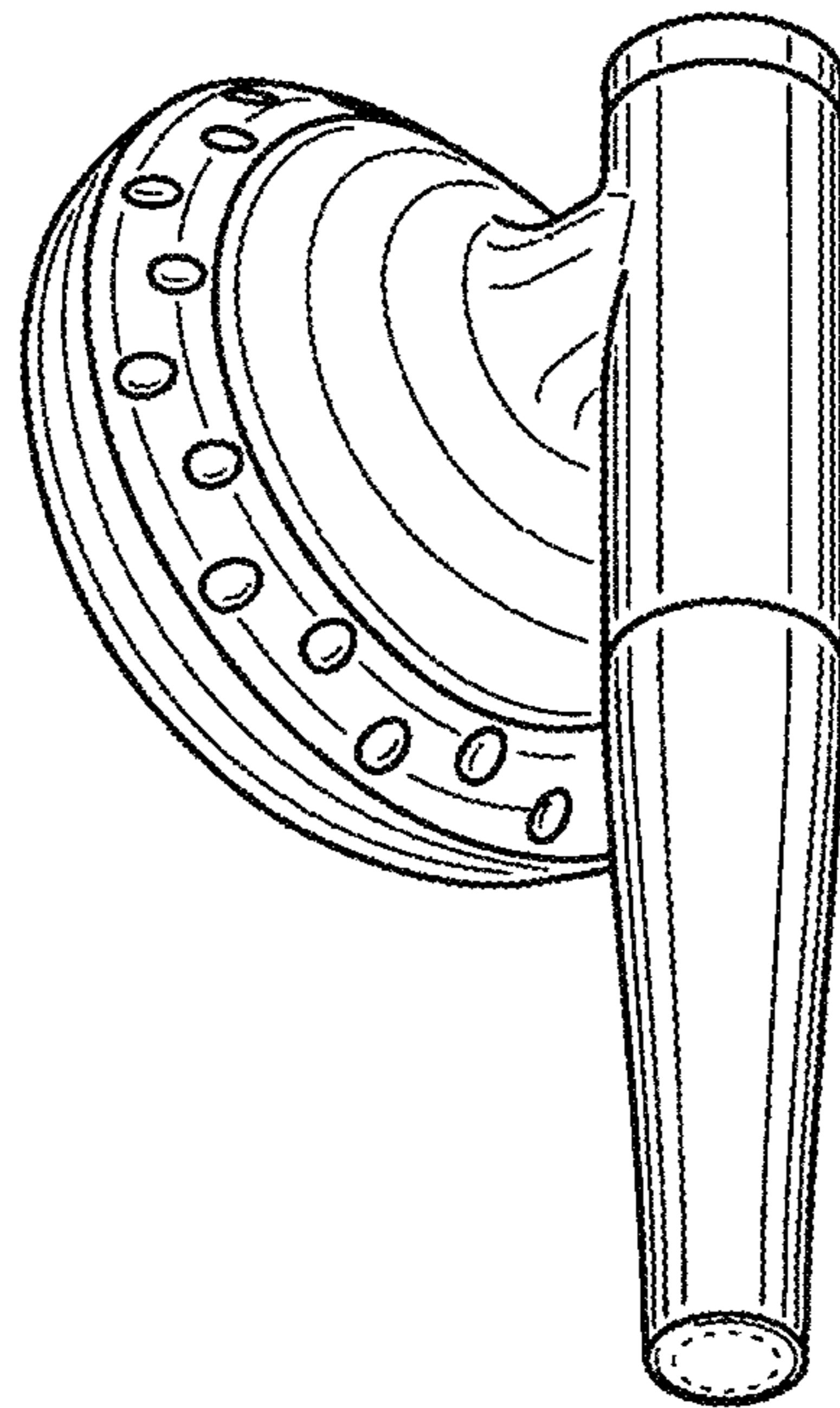


FIG. 3

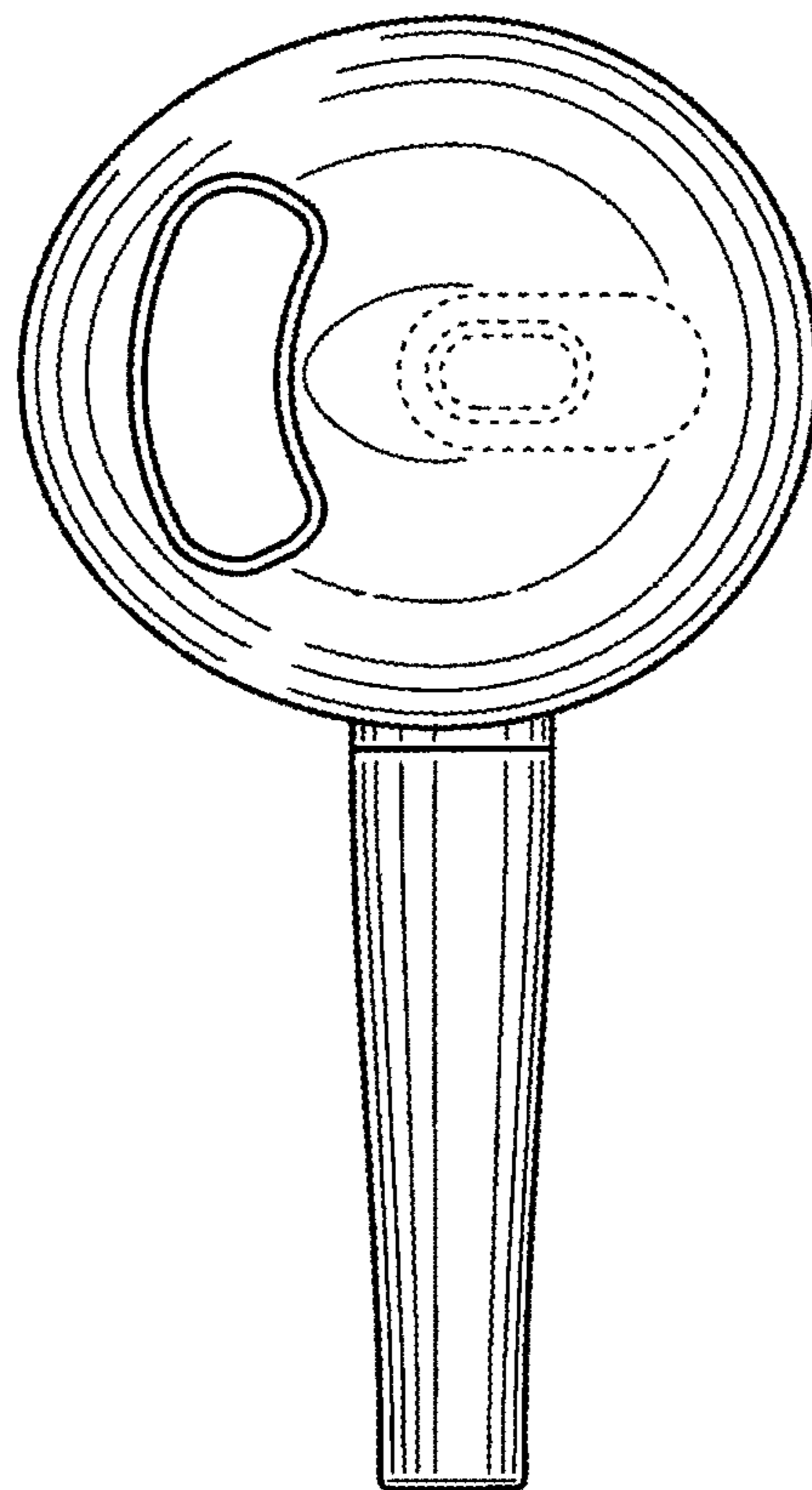


FIG. 4

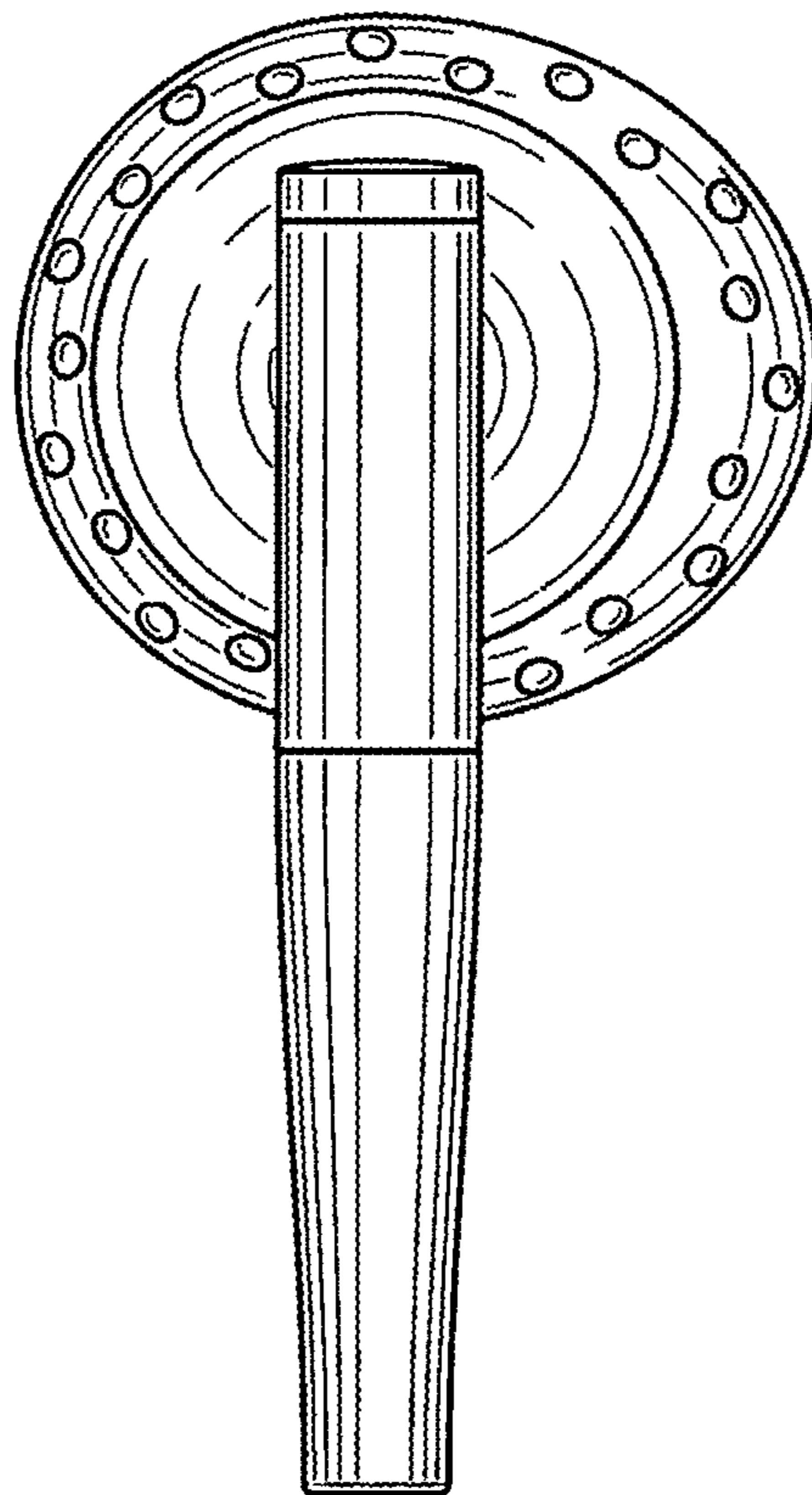


FIG. 5

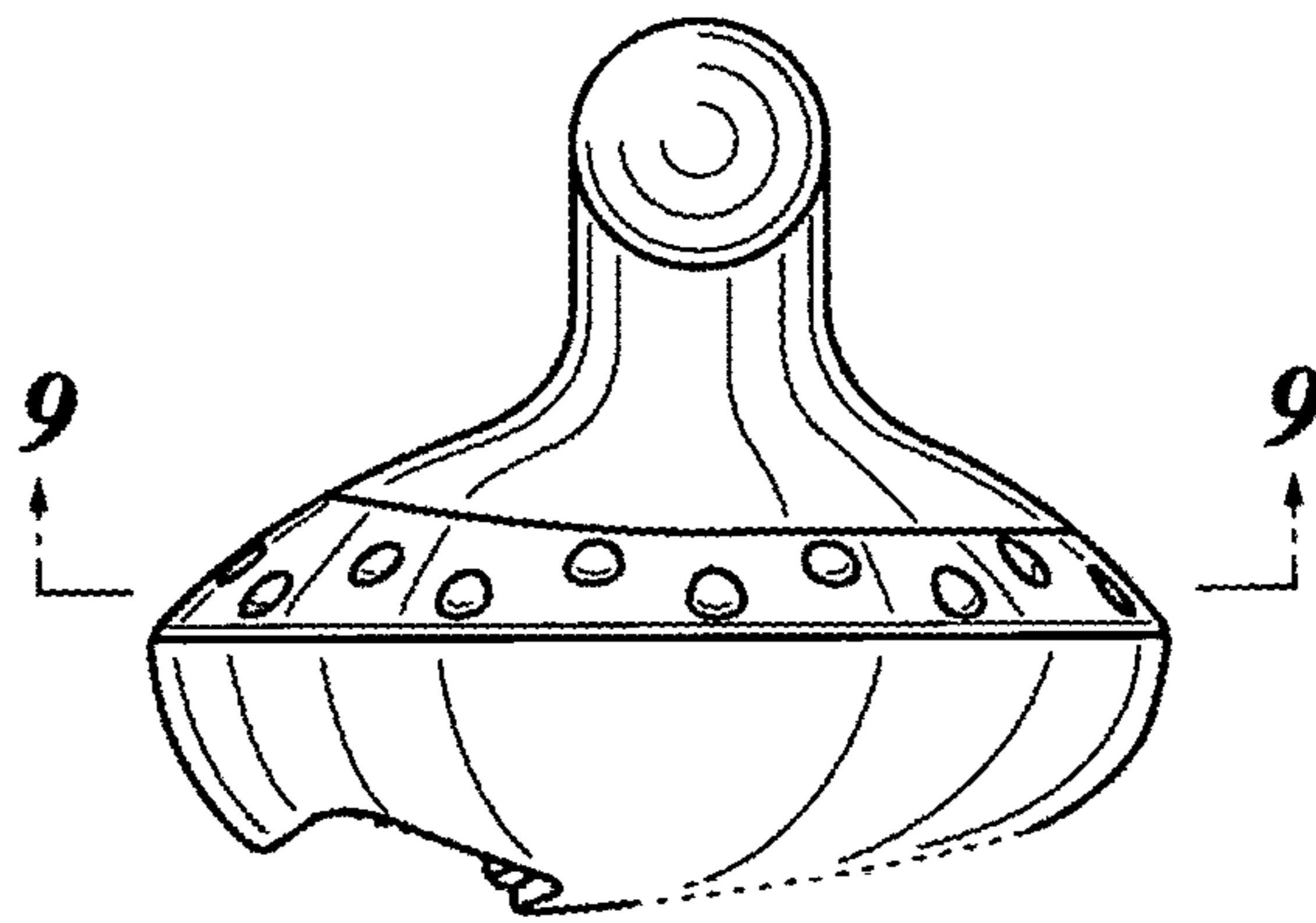


FIG. 6

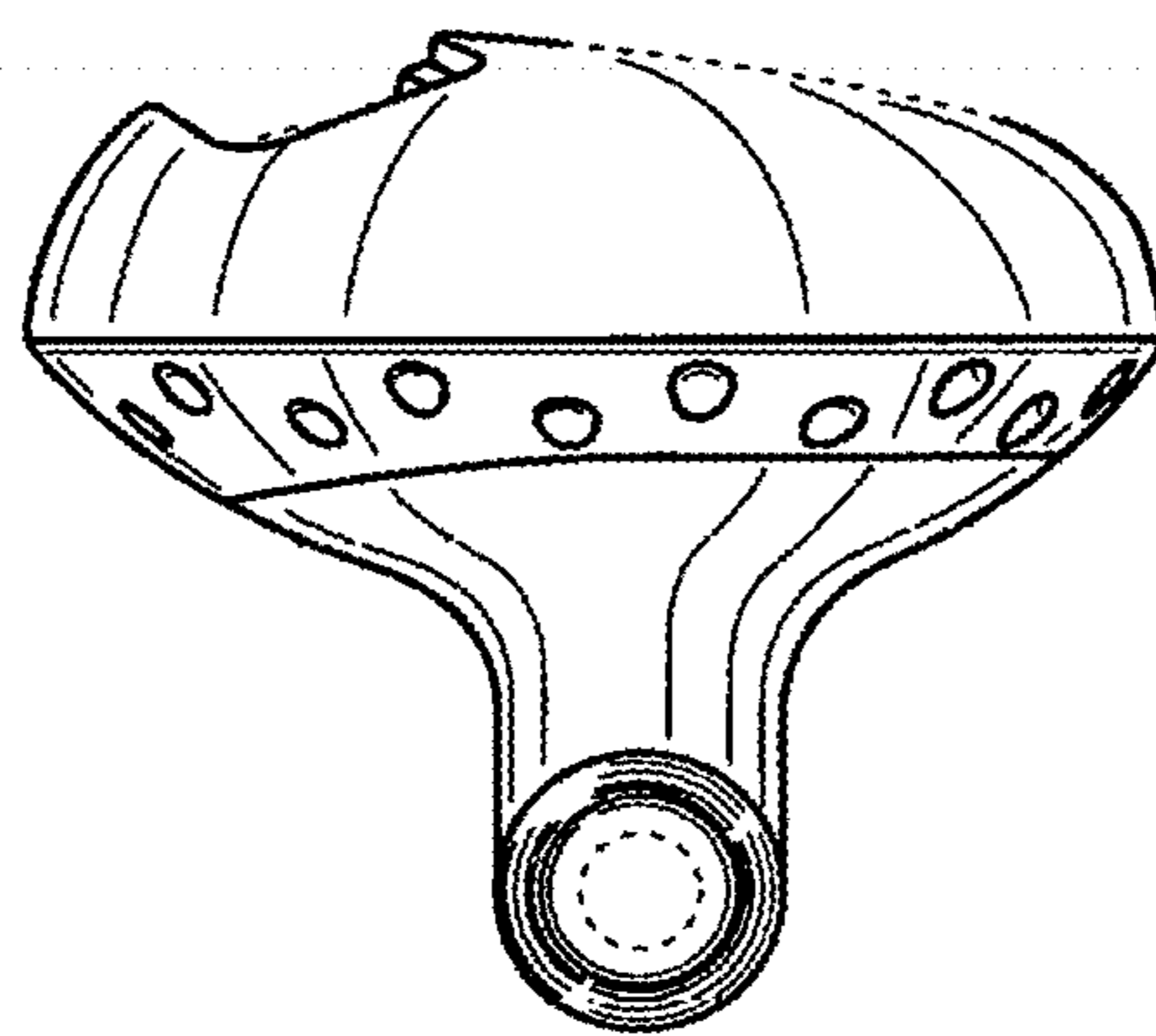


FIG. 7

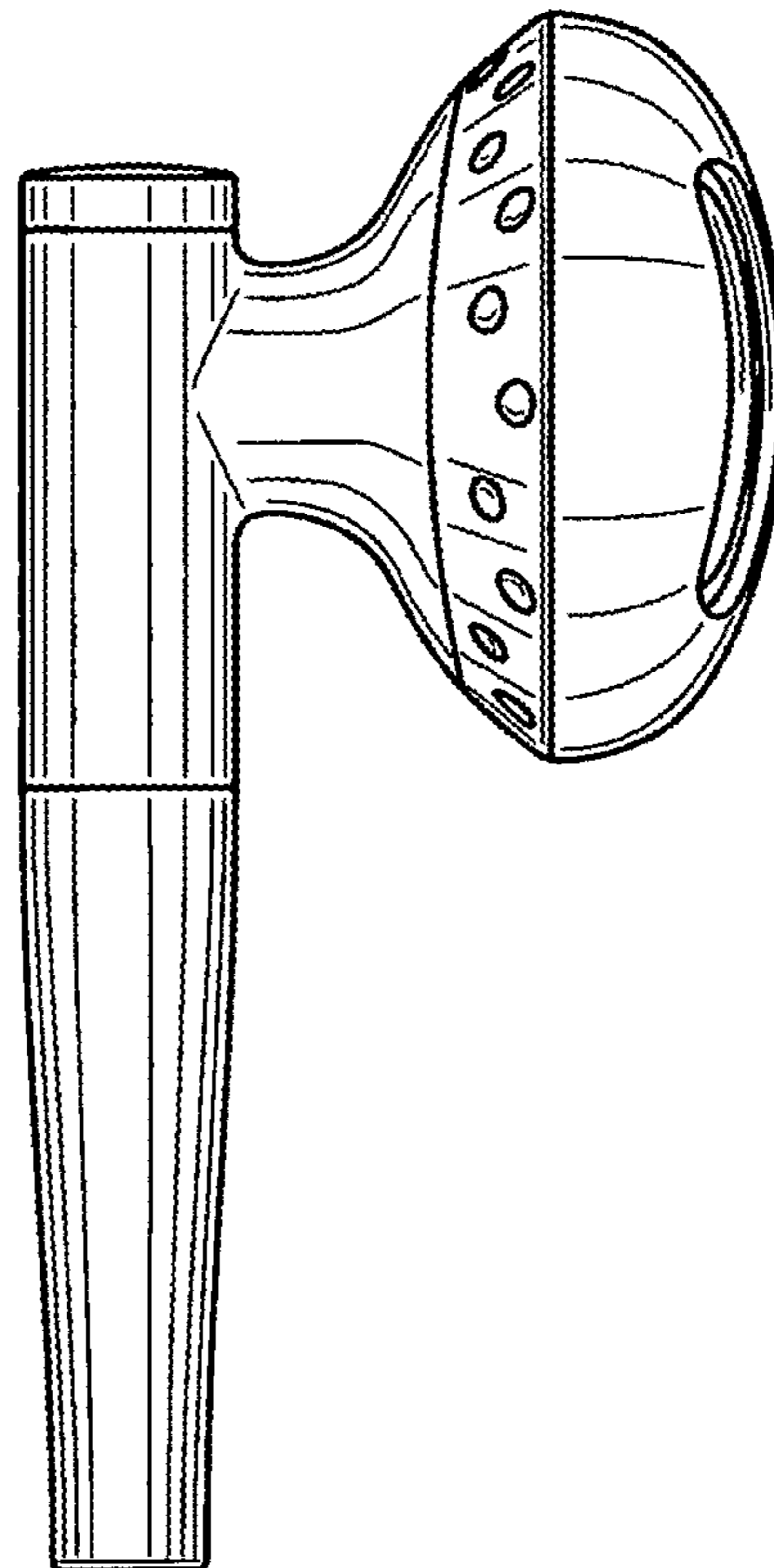


FIG. 8

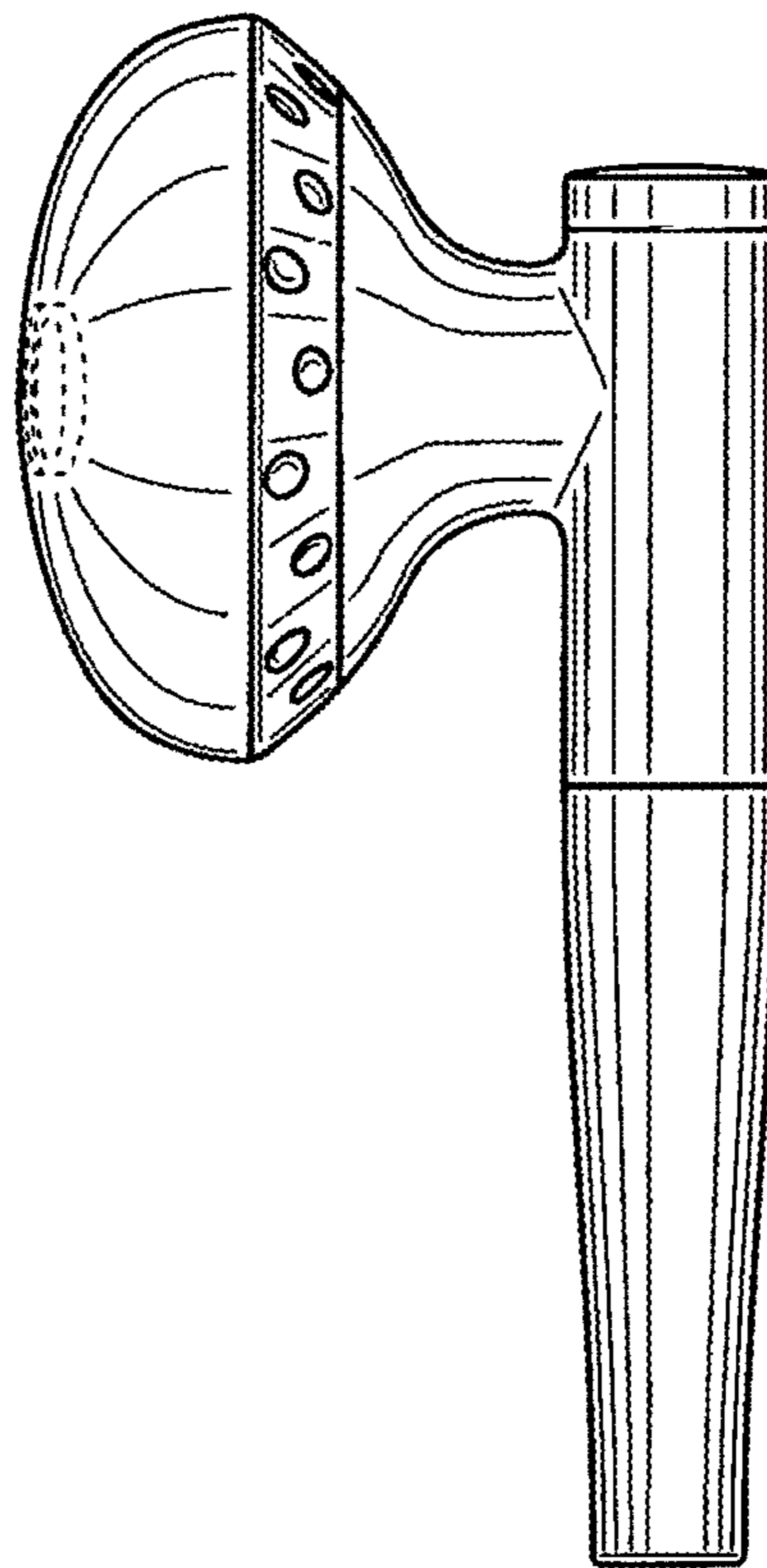


FIG. 9

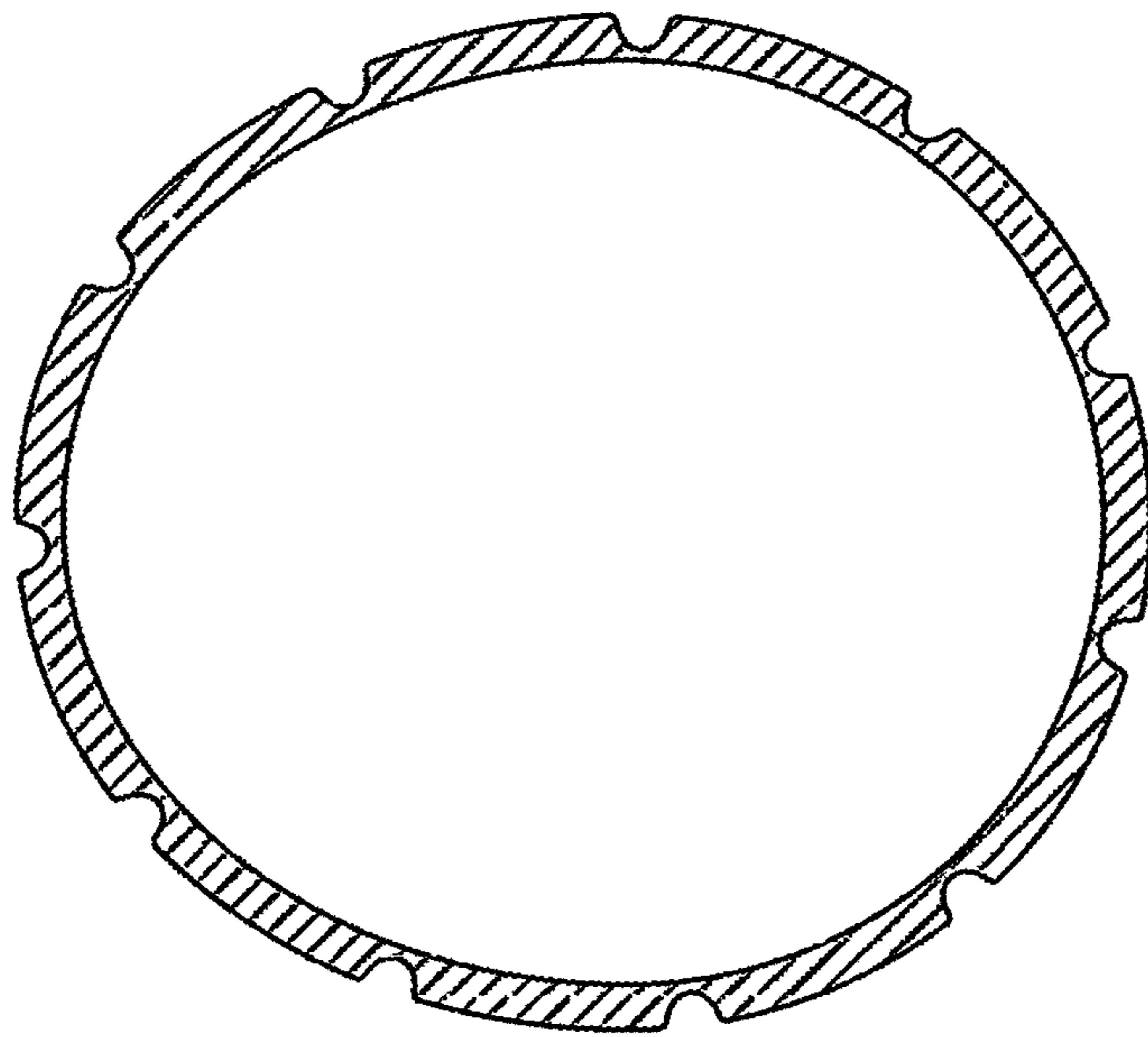


FIG. 10

